

Datasheet revision 1.2 <u>www.chipquik.com</u>

# Solder Wire Sn60/Pb40 No-Clean with 2.0% Flux Core 1oz Spool

## **Product Highlights**

No-Clean Synthetic Flux Core

The clear, non-corrosive, non-conductive residue is meant to be left on the board. 2.0% flux core

Halogen content: None

#### **Specifications**

Alloy: Sn60/Pb40
Wire Diameter: 0.015" (0.38mm)
Flux Type: No-Clean Synthetic

Flux Classification: ROL0

Melting Point: 183-188°C (361-370°F)

Packaging: 1 oz spool Shelf Life: >60 months



Yes

#### **Test Results**

| I EST VESUITS  |   |  |
|--|---|--|
| Test J-STD-004 or other requirements as stated         | Test Requirement                                      | Result   |
| Copper Mirror  | IPC-TM-650: 2.3.32                                    | L: No breakthrough   |
| Corrosion  | IPC-TM-650: 2.6.15                                    | L: No corrosion  |
| Quantitative Halides                                   | IPC-TM-650: 2.3.28.1                                  | L: <0.05%  |
| Electrochemical Migration                              | IPC-TM-650: 2.6.14.1                                  | L: <1 decade drop (No-clean)                               |
| Surface Insulation Resistance 85°C, 85% RH @ 168 Hours | IPC-TM-650: 2.6.3.7                                   | L: ≥100MΩ (No-clean)                                       |
| Visual   | IPC-TM-650: 3.4.2.5                                   | Clear and free from precipitation                          |
| Conflict Minerals Compliance                           | Electronic Industry Citizenship Coalition (EICC)      | Compliant  |
| REACH Compliance                                       | Articles 33 and 67 of Regulation (EC)<br>No 1907/2006 | Contains Lead (Pb) CAS# 7439-92-1<br>No other SVHC present |

### **Conforms to the following Industry Standards:**

J-STD-004B, Amendment 1 (Solder Fluxes):

J-STD-006C, Amendments 1 & 2 (Solder Alloys and Fluxed/Non-Fluxed Solders): Yes RoHS 3 Directive (EU) 2015/863: No